



Features

- Amplifier dissipation NPN Silicon

Package Marking and Ordering Information

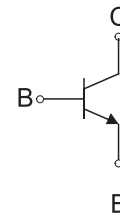
Product ID	Pack	Marking	Qty(PCS)
KSC900LBU	TO-92	HXY MOSFET	1000

1. EMITTER

2. BASE

3. COLLECTOR

TO-92



Maximum Ratings (Ta=25°C unless otherwise noted)

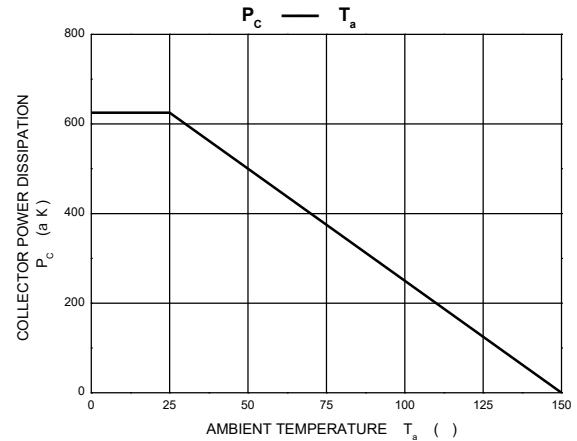
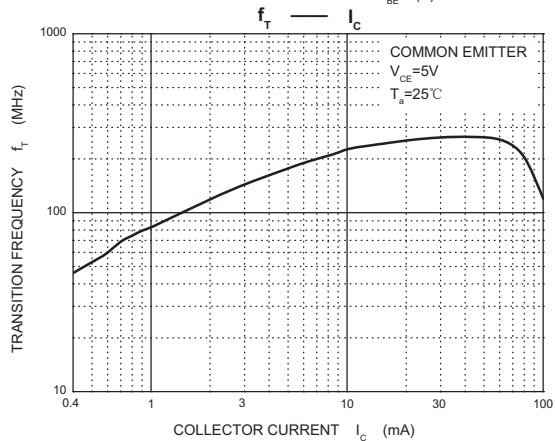
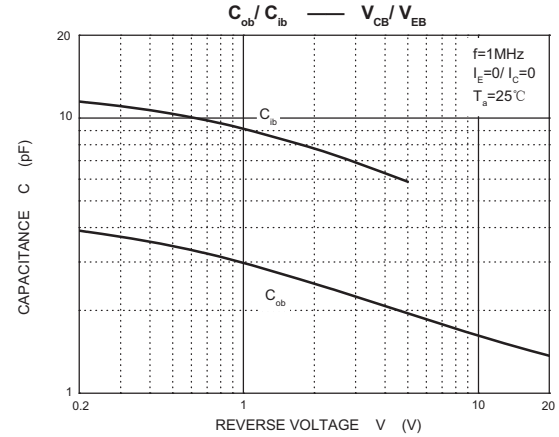
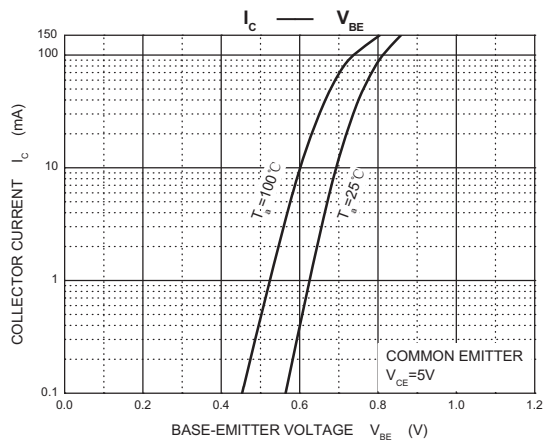
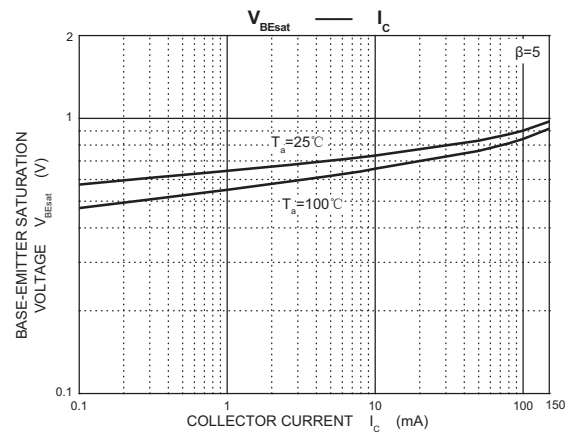
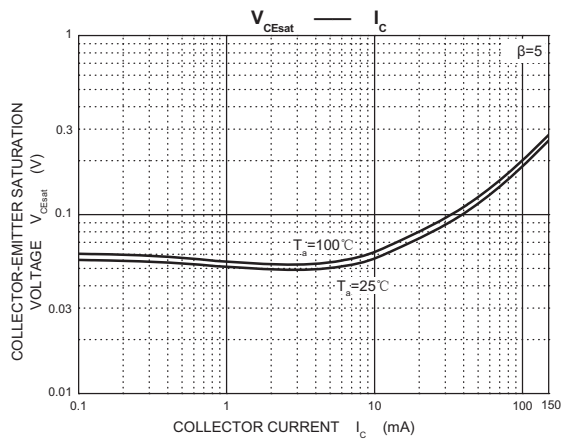
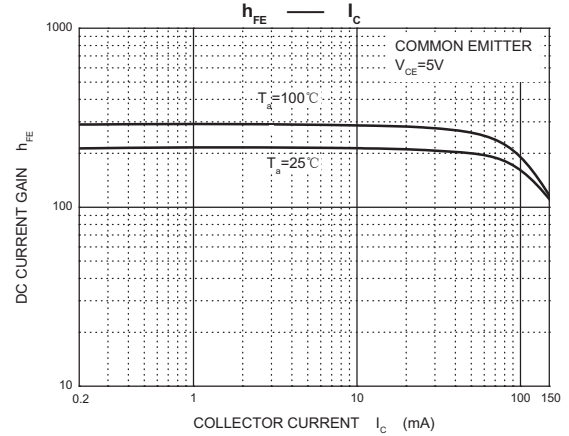
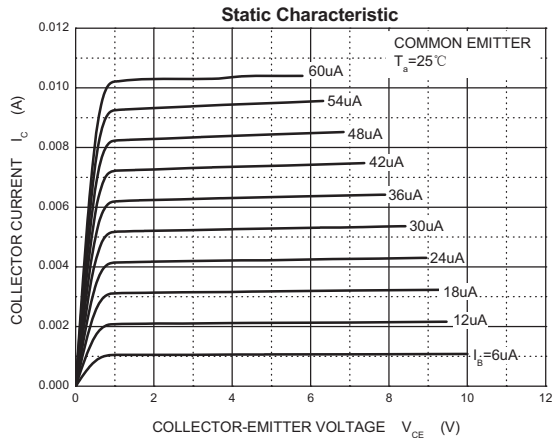
Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	50	V
V_{CEO}	Collector-Emitter Voltage	45	V
V_{EBO}	Emitter-Base Voltage	6	V
I_C	Collector Current-Continuous	0.1	A
P_C	Collector Power Dissipation	625	mW
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	200	°C/W
T_J, T_{stg}	Operation Junction and Storage Temperature Range	-55~+150	°C

Electrical Characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C = 0.1mA, I_E = 0$	50		V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C = 1mA, I_B = 0$	45		V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E = 10\mu A, I_C = 0$	6		V
Collector cut-off current	I_{CBO}	$V_{CB} = 50V, I_E = 0$		0.1	μA
Collector cut-off current	I_{CEO}	$V_{CE} = 45V, I_B = 0$		0.1	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = 5V, I_C = 0$		0.1	μA
DC current gain	h_{FE}^*	$V_{CE} = 5V, I_C = 2mA$	420	800	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 100mA, I_B = 5mA$		0.3	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = 100mA, I_B = 5mA$		1.1	V
Base-emitter voltage	V_{BE}	$V_{CE} = 5V, I_C = 2mA$	0.58	0.7	V
		$V_{CE} = 5V, I_C = 10mA$		0.75	V
Collector output capacitance	C_{ob}	$V_{CB} = 10V, I_E = 0, f = 1MHz$		4.5	pF
Transition frequency	f_T	$V_{CE} = 5V, I_C = 10mA, f = 100MHz$	150		MH

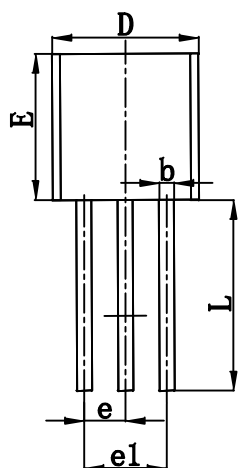
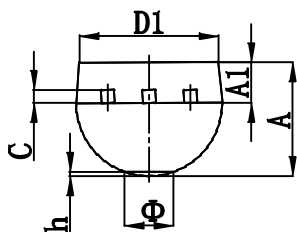


Typical Characteristics



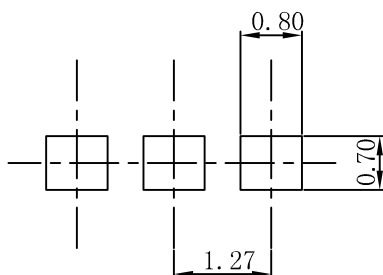


TO-92 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	3.300	3.700	0.130	0.146
A1	1.100	1.400	0.043	0.055
b	0.380	0.550	0.015	0.022
c	0.360	0.510	0.014	0.020
D	4.300	4.700	0.169	0.185
D1	3.430		0.135	
E	4.300	4.700	0.169	0.185
e	1.270 TYP		0.050 TYP	
e1	2.440	2.640	0.096	0.104
L	14.100	14.500	0.555	0.571
Φ		1.600		0.063
h	0.000	0.380	0.000	0.015

TO-92 Suggested Pad Layout



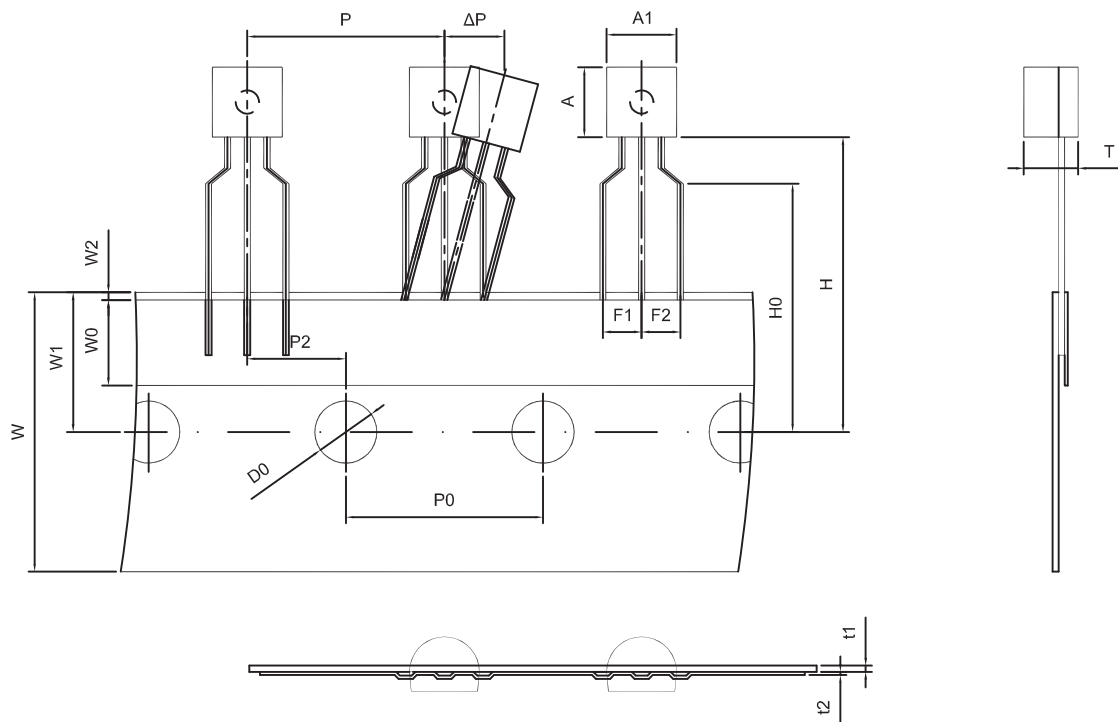
Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.



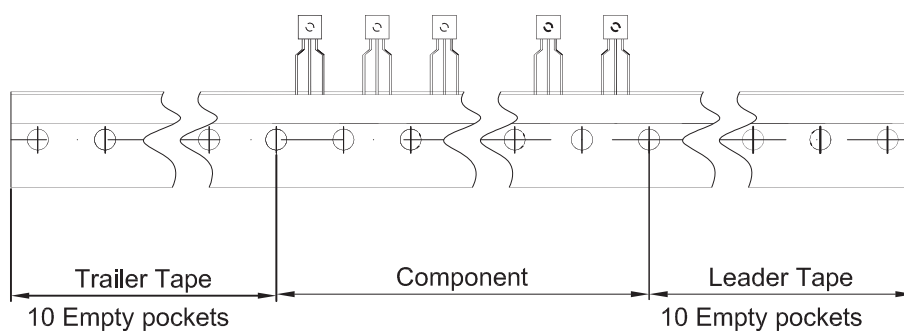
TO-92 Tape and Reel

TO-92 PACKAGE TAPING DIMENSION



Dimiensions are in millimeter

A1	A	T	P	P0	P2	F1	F2	W
4.5	4.5	3.5	12.7	12.7	6.35	2.5	2.5	18.0
W0	W1	W2	H	H0	D0	t1	t2	ΔP
6.0	9.0	1.0 MAX.	19.0	16.0	4.0	0.4	0.2	0



Package	Box	Box Size(mm)	Carton	Carton Size(mm)
TO-92	2000 pcs	333×162×43	20,000 pcs	350×340×250



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